

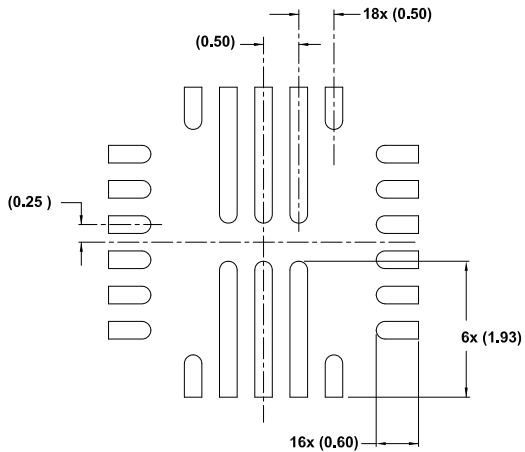
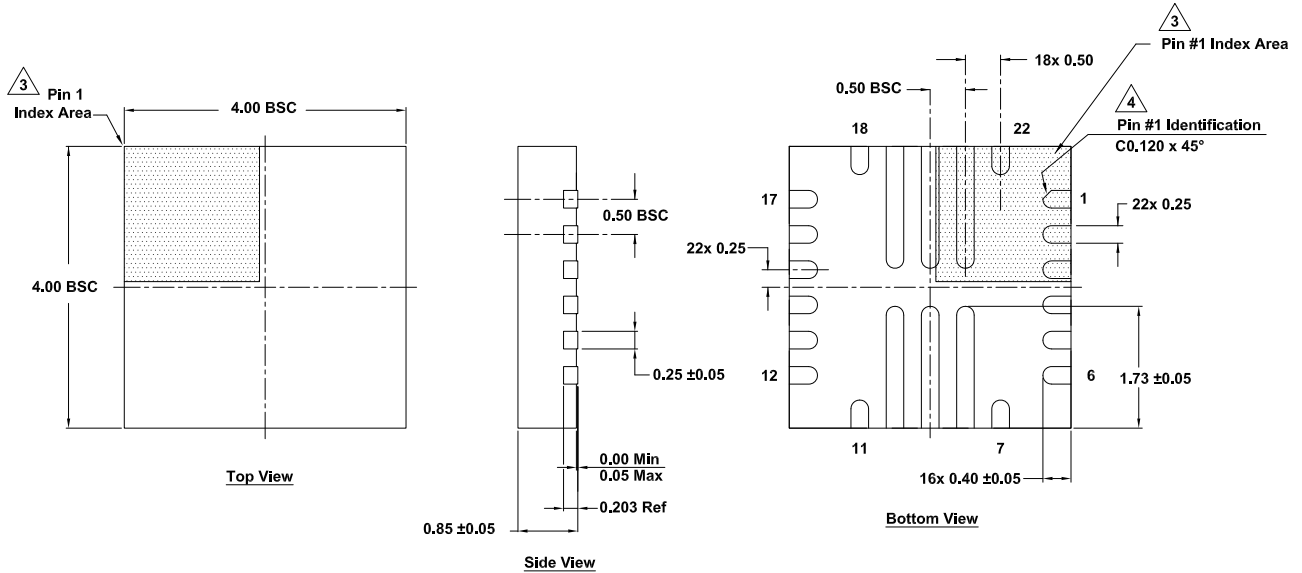
Plastic Packages for Integrated Circuits

Package Outline Drawing

L22.4x4A

22 Lead 4x4 Flip Chip Quad Flat No-Lead Package (FCQFN)

Rev 0, 7/20



Typical Recommended Land Pattern

Notes:

1. Dimensions are in millimeters.
Dimensions in () for reference only.
2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
3. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier can be either a mold or mark feature.
4. Pin 1 corner chamfer not required.
5. Unless otherwise specified, tolerance: Decimal ± 0.05